

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT5471811

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
GANDHI KARUNA K T	02/08/2019
RECEIVING PARTY DATA	
Name:	HCL TECHNOLOGIES LIMITED
Street Address:	A-9, SECTOR - 3
Internal Address:	NOIDA
City:	UTTAR PRADESH
State/Country:	INDIA
Postal Code:	201 301
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16275613
CORRESPONDENCE DATA	
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<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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ATTORNEY DOCKET NUMBER:	LEGASIS 19.06
NAME OF SUBMITTER:	DANIEL H. LANDAU
SIGNATURE:	/daniel h.landau/
DATE SIGNED:	04/12/2019
Total Attachments: 2	
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source=assignment#page2.tif	

ASSIGNMENT

WHEREAS, ASSIGNOR, comprising of the following named inventor: **Gandhi Karuna K T** has invented, conceived, reduced to practice, invention for "**SYSTEM AND METHOD FOR MULTI-LEVEL AMPLITUDE MODULATION AND DEMODULATION**" (hereinafter the "Invention") for U.S. Patent Application No. 16/275,613 was filed on February 14, 2019 hereinafter the "Application"); and

WHEREAS, ASSIGNEE, **HCL Technologies Limited**, an Indian Company, having a principal place of business at A-9, Sector - 3, Noida 201 301, Uttar Pradesh, India is desirous of acquiring the entire right, title and interest in, to an under the Invention, application and patents to be obtained thereon;

NOW, THEREFORE, in consideration of the payment by ASSIGNEE to ASSIGNOR the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration, ASSIGNOR does hereby sell, assign and transfer and set over to ASSIGNEE, its successors, legal representatives and assigns, the entire right, title and interest throughout the world, in the Invention including, but not limited to , any patent rights, and any patent application(s), claiming priority thereto, that have been or may hereafter be filed;

ASSIGNOR, does hereby covenant that no assignment, sale, agreement, charge or other encumbrance, has been, or will be, entered into which would conflict with this assignment;

ASSIGNOR, does hereby covenant and agree to provide any tangible property embodying or describing the invention, including, without limitation, all documents, drawings, prototypes, models, test results, designs, materials, computer programs and data, and the like, which, if not presently in the possession of ASSIGNEE will be delivered to ASSIGNEE immediately upon request;

ASSIGNOR, does hereby covenant and agree to do everything possible to aid ASSIGNEE, its successors, legal representatives and assigns obtain and enforce proper patent protection for the invention in all countries including assisting with the preparation of any application relating to the invention;

ASSIGNOR, does hereby covenant and agree not to contest the validity or enforceability of any intellectual property rights assigned herein, or to assist or request any third party to contest the validity or enforceability of any intellectual property rights assigned herein;

ASSIGNOR does hereby release and forever discharge ASSIGNEE from any and all claims, including but not limited to debts, liabilities, damages and causes of action of whatsoever kind or

nature relating to the Invention, whether or not known, suspected and unsuspected, including any and all previous agreements entered into, which now exist, or may have existed prior to the date of this assignment.

IN TESTIMONY WHEREOF, I have hereunto set my hand this 08 day of February 2019

Signature: K. T. Gandhi

Name: **Gandhi Karuna K T**